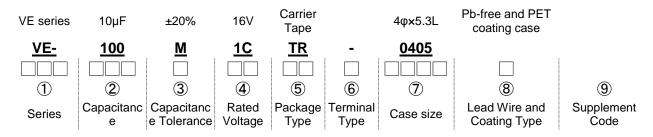
Dwg. No. :<u>H19-2053</u> 承認字號 Issued Date: <u>2019/6/25</u>

Customer :	
(客 戶) Part No. : (貴公司料號)	
SPECIFICATIO	N FOR APPROVAL 認 書
Description : <u>V-CHIP ALUMI</u> (零 件 名 稱)	NUM ELECTROLYTIC CAPACITORS
Lelon Series : (立 隆 系 列)	VZH Series
Lelon Part No.: (立 隆 料 號)	VZH680M1ETR-0605
TEL: +886-4-2418 Manufacturing Site Lelon Electronic 147, Sec. 1, Guog TEL: +886-4-2418 Lelon Electronic Taiyang Industrial Guangdong, Chin TEL: +86-752-876 Lelon Electronic 1220, Zhongshan Development Zon	s Corp. guang Rd,. Dali District, Taichung, Taiwan 81856 FAX: +886-4-24181906 s (Huizhou) Co., Ltd. Zone, Baihua Town, Huidong County, Huizhou City,
	Approval Signatures 貴公司承認印
Approval 核准Check 確認Design 作成R & D JUN. 25. 2019 Jack HuangR & D JUN. 25. 2019 H. Y. HuangR & D JUN. 25. 2019 Z. X. Sun	Please Return One Copy with Your Approval 承 認 後 請 寄 回 本 圖 一 份

RDD0346A, A4, 970102

Part Numbering System

Product Code Guide - SMD Type



1 Series:

Series is represented by a three-letter code. When the series name only has two letters, use a hyphen, "-", to fill the third blank.

2 Capacitance:

Capacitance in μ F is represented by a three-digit code. The first two digits are significant and the third digit indicates the number of zeros following the significant figure. "R" represents the decimal point for capacitance under 10 μ F.

Example:

Capacitance	0.1	0.47	1	4.7	10	47	100	470	1,000	4,700	10,000
Part number	0R1	R47	010	4R7	100	470	101	471	102	472	103

③ Tolerance:

J = -5% ~ +5%	K = -10% ~ +10%	M = -20% ~ +20%	V = -10% ~ +20%

4 Rated voltage:

Rated voltage in volts (V) is represented by a two-digit code

Voltage (WV)	2.5	4	6.3	10	16	20	25	35	40	50	63	80	100
Code	0E	0G	0J	1A	1C	1D	1E	1V	1G	1H	1J	1K	2A
Voltage (WV)	160	200	250	350	400	450							
Code	2C	2D	2E	2V	2G	2W							

⑤ Package:

TR = Reel package	T- = Tray package for case diameter 12.5 ~ 18mm

(6) Terminal:

- = No dummy terminal	K = Anti-vibration structure (30G)
A = For automotive application (10G)	G = Anti-vibration structure (50G)

⑦ Case size:

The first two digits indicate case diameter and the last two digits indicate case length in mm.

φD×L	3×5.3	4×4.5	4×5.3	4×5.7	5×4.5	5×5.3	5×5.7 5×5.8	6.3×4.5	6.3×5.3	6.3×5.7 6.3×5.8
Code	0305	0404	0405	0406	0504	0505	0506	0604	0605	0606
φD×L	6.3×7.7	8×6.5	8×10	10×7.7	10×10(9.9)	10×12.5	12.5×13.5	12.5×16	16×16.5	16×21.5
Code	0607	0806	0810	1008	1010	1013	1313	1316	1616	1621
φD×L	18×16.5	18×21.5								

Code 1816 1821

Note 1: When a case size is required and not shown in the table, please contact with us for further discussion. Note 2: The case size "5x5.8, 6.3x5.8" is for VZS series only.

(8) Lead Wire and Coating Type:

None = Pb free wire + PET coating case (Standard design)	E = Sn-Bi wire + PET coating case
B = Sn-Bi wire + Coating case	K / L = Automotive control code

* When a supplement code following a blank digit code of lead wire and case coating type (standard design), use a hyphen, "-", to fill the blank digit.

* When the automotive control code is required, please contact with us for further discussion.

(9) Supplement code (Optional):

For special control purpose

$68~\mu F$ / $25~V-6.3\phi$ $\times 5.3L$

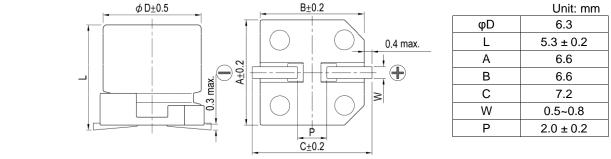
Page: 1 / 1

VZH

CUSTOMER

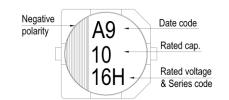
CUSTOMER P/N:

PRODUCT DIMENSIONS



Items				Pe	rformance					
Rated Voltage V _R					25 V					
Capacitance C _R					68 µF				(120 Hz, 20	°C)
Category Temperature Range				-55 °C	~ +105 ℃					
Capacitance Tolerance				-20 %	~ +20 %				(120 Hz, 20	°C)
Surge Voltage Vs				2	8.8 V _{DC}					
Leakage Current (20°C)				ILEAK	$c \leq 17 \ \mu A$				After 2 minu	utes
Tan δ					≦ 0.16				(120 Hz, 20	°C)
Impedance max.		$<$ 0.44 Ω (100k Hz, 2								
Ripple Current (I _{AC, R} / rms)		230 mA								
Low Temperature Characteristics at 120 Hz		Impe	dance ratio	Z _(-25°C) / Z _{(+20°C}						
Characteristics at 120 Hz				Z _(-55°C) / Z _{(+20°C})	3	3		
Ripple Current (A) and	Fre	equency (cy (Hz) 50,60		120		1k 10		ρ	
Frequency Multipliers		Multiplier	0.60		0.70		0.85	1.0		
	Items	E	ndurance			Shelf	Life Tes	t		
	Test Time	2	,000 Hrs at 105	°C; V _R	2	1,000	Hrs at 1	105 ℃		
Endurance and Shelf Life Test	Cap. Chang	je V	/ithin ±30 % of	initial	value	Withi	n ±30 %	of initial va	alue	
1651	Tan δ	L	ess than 300%	of spe	cified value	Less	than 300)% of spec	ified value	
	Leakage Cu	irrent V	/ithin specified	value		Within specified value				
Standards			JIS C	5101-	1, -18, IEC 6	0384-4	ł			
Remarks			RoHS	Comp	liance, Halog	gen-fre	е			

Marking: Each capacitor shall be marked with the following information.



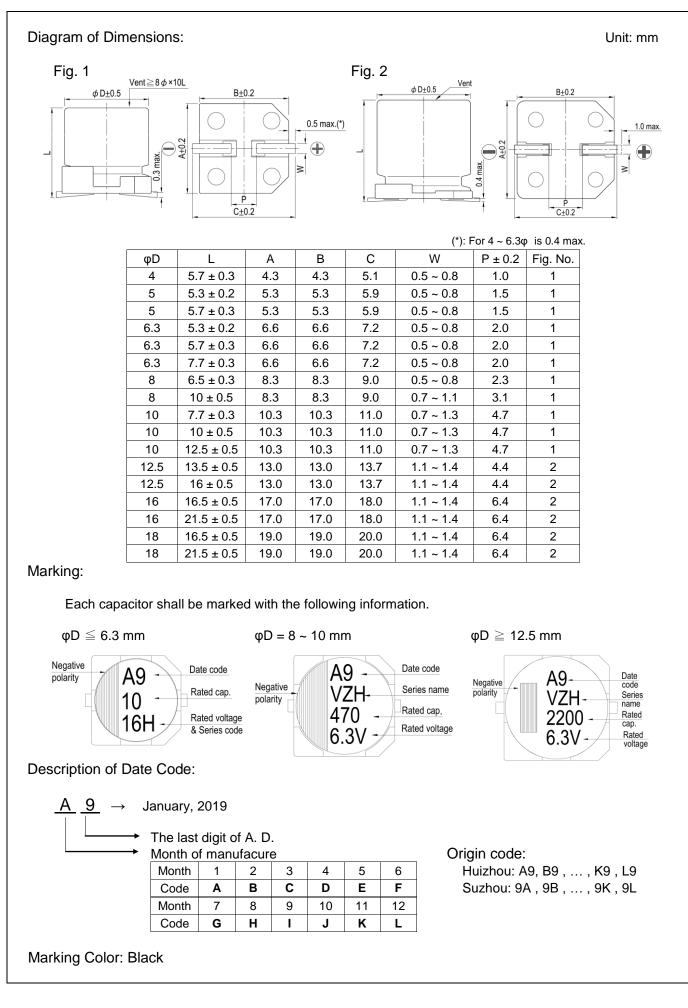
/										
				-						
	Month	1	2	3	4	5	6			
	Code	А	В	С	D	E	F			
	Month	7	8	9	10	11	12			
	Code	G	Н	I	J	К	L			

Marking color: Black

* Please refer to "Precautions and Guidelines for Aluminum Electrolytic Capacitors" section in Lelon's catalog for further details.

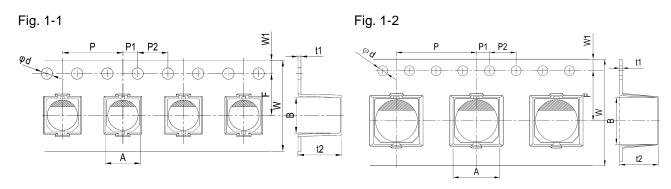
Publication Date	June 25, 2019	Approval Signatures:	Approved	Checked	Designed
Revision Date			R&D	R & D	R & D
Version No.	1	Please return one copy with your approval	Jack Huang	JUN. 25. 2019 H.Y.Huang	JUN. 25. 2019 Z.X.Sun

VZH-MK-07

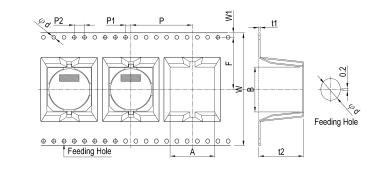


Taping Specification for SMD Type

1. Carrier Tape







		_		_		54	50					Unit: mm
φD×L	A	В	φd	F	P	P1	P2	t1	t2	W	W1	Fig. No.
3~4 ×4.5~5.3	4.7	4.7	-	5.5	8				5.8			1-1
4 ×5.7	4.7	4.7	-	5.5	8				6.2	12.0		
5 ×4.5~5.3	5.7	5.7	_	5.5	12				5.8			
5 ×5.7 ~ 5.8	5.7	5.7	_	5.5	12				6.2		_	
6.3 ×4.5~5.3	7.0	7.0						0.4	5.8			
6.3 ×5.7 / 5.8	7.0	7.0		7.5	12				6.2	16.0		
6.3 ×7.7	7.0	7.0							8.3			1-2
8 ×6.5	8.7	8.7							6.8			
8 ×10									11.0			
8 ×10.5(G)	9.2	9.2						0.5	11.2			
10 ×7.7	10.7	10.7		11.5	16	2.0	4.0	0.4	10.0	24.0		
10 ×10			1.5						11.0		1.75	
10 ×10.5(G)	11.2	11.2							11.2			
10 ×12.5	10.7	10.7							13.0			
12.5 ×13.5	13.4	13.4	-						15.0			
12.5 ×13.5(G)	13.7	13.7	-	14.2	24				15.0	32.0		
12.5 ×16	13.4	13.4							17.5			
12.5 ×16(G)	13.7	13.7	-					0.5	18.0		-	
16 ×16.5	17.5	17.5	-						17.5			1-3
16 ×16.5(G)	17.5	17.5			28				20.0	44.0		
16 ×21.5	17.5	17.5	1	20.2					22.5			
18 ×16.5	19.5	19.5			32				17.5			
18 ×21.5	19.5	19.5	_						22.5			
Tol.	± 0.2	± 0.2	+0.1/-0	± 0.1	± 0.1	± 0.1	± 0.1	± 0.1	± 0.2	± 0.3	± 0.15	

Note: Case size in mark of "G" are for "Anti-vibration".

2. Reel Package

Fig. 2-1

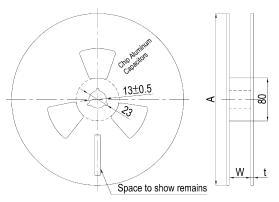
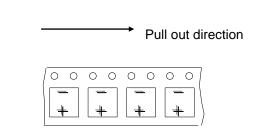
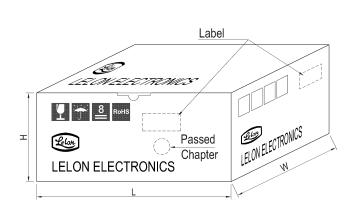


Fig. 2-2 Reel Polarity



Case size	$3 \sim 4 \phi$	5Φ	6.3 <i>¢</i>	8φ × 6.5	8 <i>¢</i> ×10	10 <i>¢</i>	12.5ϕ	$16 \sim 18 \phi$
W	14	14	18	18	26	26	34	46
А	380	380	380	380	380	380	380	380
t	3.0	3.0	3.0	3.0	3.0	3.0	3.0	3.0

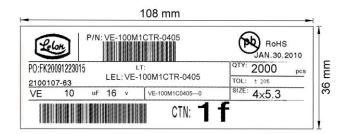
3. Packing specification Fig. 3-1 Carrier Tape



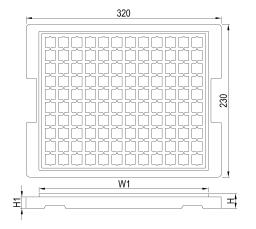
		Unit: pcs
Case size	Q'ty / Reel	Q'ty / Box
3φ	2,000	20,000
4φ	2,000	20,000
5ϕ	1,000	10,000
6.3ϕ	1,000	10,000
8φ×6.5	1,000	10,000
8 <i>¢</i> ×10L	500	5,000
$10\phi \times 7.7 \sim 10L$	500	5,000
10 <i>ф</i> ×12.5L	400	4,000
12.5¢×13.5L	200	1,600
12.5 <i>¢</i> ×16L	200	1,600
16φ×16.5L	200	1,600
16φ×21.5L	100	800
18¢×16.5L	150	1,200
18 <i>¢</i> ×21.5L	100	800

								Unit: mm
Case size	$3 \sim 4 \phi$	5ϕ	6.3ϕ	$8\phi \times 6.5$	$8\phi \times 10$	10ϕ	12.5 ϕ	$16 \sim 18 \phi$
Н	210	210	250	250	330	330	330	425
W, L	395	395	395	395	395	395	395	395

Fig. 3-2 Label



4. Chip Tray

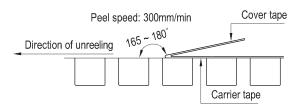


Dimension and package quantity									
W1	н	H1	Q'ty / Tray	Q'ty / Box					
284	21	18.5	120	600					
284	21	18.5	120	600					
284	28	24.0	80	400					
284	28	24.0	80	400					
284	28	24.0	60	300					
284	28	24.0	60	300					
	W1 284 284 284 284 284 284	W1 H 284 21 284 21 284 28 284 28 284 28 284 28 284 28 284 28	W1 H H1 284 21 18.5 284 21 18.5 284 28 24.0 284 28 24.0 284 28 24.0 284 28 24.0	W1 H H1 Q'ty / Tray 284 21 18.5 120 284 21 18.5 120 284 21 18.5 120 284 21 18.5 120 284 28 24.0 80 284 28 24.0 80 284 28 24.0 60					

5. Sealing Tape Reel Strength

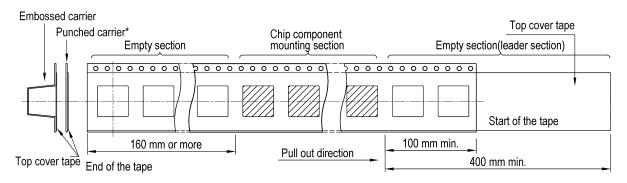
5.1 Peel angle: 165 to 180°C refered to the surface on which the tape is glued.

- 5.2 Peel speed: 300mm per minutes
- 5.3 The peel strength must be 0.1 \sim 0.7N under these conditions.



6. Packing Method

- 6.1 The leader length of the tape shall not be less than 400 mm including 10 or more embossed sections in which no parts are contained.
- 6.2 The winding core is provided with an over 160mm long empty section; punched carrier is only suitable for $\phi D \leq 5$ mm.



Endurance characteristic:

	urance characte	ISUC:	0								0	-: (; +;	
No. 1	Item Rotational	Conceitor in I		ondition	-	o tomo	oroturo	-	onooita	naa	Specification		
	Temperature Test	Capacitor is placed in an oven whose temperature follow specific regulation to change. The specific							Capacitance change		Within \pm 10% of initial value		
									anō		Within s	pecified value	
		+25°C (3 min min.)", and it							eakage urrent	•	Within s	pecified value	
		cycles, and th	hen the ca	pacito	r shall I	be sub	jected to		hysical		No brok	en and undamaged	
		standard atm	•				s, after						
2	High Temperature	which measu 1. Capacitors						С	apacita	ince			
	Endurance Life	application	of rated v	oltage					nange		Within ±	: 30% of initial value	
	Test	2,000 +72	/ -0 hours	for ϕ [$O \leq 6.3$	3mm, 8	3φ ×	T	anδ		Less that	an 300% of specified value	
		6.5mm and 5,000 +72			$0 \ge 8 r$	nm an	$\leq 1 \mathrm{b}$		eakage urrent		Within s	pecified value	
		10mm at 1							hysical		No brok	en and undamaged	
		2. Then the c standard a after which	atmospher	ic cond	ditions	for 4 h							
3	High Temperature	After 1,000 +	48 / -0 hou	urs tes	t at 105	5℃ wit			apacita	ance	Within ±	: 30% of initial value	
	Unload Life Test	rated voltage			-				nange				
		be subjected for 4 hours, a			•				anō eakage			an 300% of specified value	
		made.		meas	urenner	115 5110	li De	С	urrent			pecified value	
									hysical		No brok	en and undamaged	
4	Humidity Test	Capacitors sl hours in an a							Capacitance change		Within ± 10% of initial value		
		3℃.							Tanδ		Less than 120% of specified value		
		And then the capacitor shall be subjected to standard atmospheric conditions for 4 hours, after							Leakage Within specified value			pecified value	
			which measurements shall be made.						hysical		No broken and undamaged		
5	Low Temperature Test		Capacitors are placed at $-55 \pm 3^{\circ}$ C for 96 ± 4 hours. And then the capacitor shall be subjected to						apacita nange	ance	Within ±	10% of initial value	
		standard atm	•				s, after		anō		Within specified value		
		which measu	irements s	hall be	made				eakage urrent	•	Within specified value		
									hysical		No broken and undamaged		
6	Vibration Test	1. Fix it at the ones of 12							Capacitance change Within ± 10% of initial va			10% of initial value	
		or more ler	•	•		re.			anō		Within specified value		
		2. Direction a 3 orthogon				ach for	2 hours		eakage urrent		Within specified value		
		(total of 6 h		15 mat	ually c		Z nour		hysical		No brok	en and undamaged	
		3. Frequency 10 to 55 Hz		ntion fo	r 1 mir	outo							
		4. Total ampl				iute.							
7	Surge Voltage Test	The capacito 15 ~ 35℃. Pi	r shall be s	subject					Capacitance change		Within ±	20% of initial value	
		consisting of							anō		Less tha	an 175% of specified value	
		followed by d minutes.						L	eakage urrent			pecified value	
		minutoo.							hysical		No brok	en and undamaged	
		Applying volt	-		1	[· · ·						
			/oltage(V)	6.3	10	16	25	35	50	63	80	100	
		Surge \	/oltage(V)	7.3	11.5	18.4	28.8	40.3	57.5	72.5	92	115	

No.	Item		Conditions	Specification					
8	Solder Heat-	1. IR Reflow	10	Capacitance	Within ± 10% of initial value				
	Resistance Test	T4		change Tanō	Within specified value				
		T3		Leakage					
		(°C)		Current	Within specified value				
		ar T2		Physical	No broken and undamaged				
		T2	t1 t2						
		H H							
			Time(sec)						
		Rated voltage (V)	4 ~ 50 63 up 4 ~ 100						
		Case size (ϕ)	3~6.3 3~6.3 8~18						
		Temp. (T1 T3 ℃)	150 ~ 180						
		Preheat $(T1 \sim T2, \degreeC)$ Time (t1)	100						
		(max., secs)							
		Duration Temp. (T3, °C Time (t2)							
		(max., secs)	90 60 60 60 40						
		Peak Temp. (T4, °C							
		Time (t3, secs	2 or less						
		2. Solder iron method:							
		Bit temperature: 350 ±							
			dering Iron: 3 +1 / -0 sec presentative if your condition is						
		higher.							
			The capacitor became cold enough to $(5^{\circ}C \sim 35^{\circ}C)$ before the second						
		reflow.							
		* Consult with us wher JEDEC (J-STD-020)	performing reflow profile in IPC /						
9	Mechanical	Bending Test:			nanical damage such as				
	Characteristics Test		irection of the arrow at a rate of ent width reaches 2 mm and hold		rical characteristics shall be here are electrodes on both				
	1051	for 60s. The board sha	I be the test board "B" as specified in	surfaces, abo	ove requirements shall be				
		JIS C 0051: 2002. If the specified clearly in the	e land area differs, it shall be	satisfied on w fixated on.	whichever surface it may be				
		specified clearly in the							
		Substrate	Substrate during ter		Bending tool				
		before test		Radius 5					
			1,6 mm ± 0,20 mm []])					
			Support Radius 2,5 mm		Length = actual width				
		Specimen (of SMD)	45 mm ± 2 mm	1	of substrate + 5 (minimum) on both sides				
10	Solderability		mersed in the solder for 2 ± 0.5 secs	at a temperatu	re of 245 \pm 5°C, the solder the				
11	Test Venting Test	solder coating must be m	ore than 95%. citors with case size is 8×10 mm and I	arger					
	voning 163	2. Test condition:							
			tor shall be connected across an appl		Iz AC which is 0.7 times of				
		rated voltage or 250Vrms AC whichever is the lower. (2) DC test: Applying inverse DC rated voltage with current to the capacitor.							
			er: $\phi D \leq 22.4$ mm: 1 A DC max.						
		Note:	ϕ D $>$ 22.4 mm: 10 A DC max.						
		(1) When the pressure	relief vent operated, the capacitor sha	II avoid any da	nger of fire or explosion of				
			erminal and metal foil etc.) or cover. relief device does not open with the v	ltage applied	over 30 minutes the test is				
		considered to be pa		onaye applied (5 50 minutes, the test is				
		·							

No.	Item	Conditions								
12	Land Pattern	Recommended pad pattern and size								
			Case size	L	and siz	е	Case size	L	and size	e
		G Y		G	Y	Х		G	Y	Х
			4φ	1.0	2.6	1.6	8φ	3.0	3.5	2.5
		<i>₩₩₩₩₩₩</i>	5Φ	1.4	3.0	1.6	10 <i>¢</i>	4.0	4.0	2.5
			6.3 <i>¢</i>	1.9	3.5	1.6	12.5 <i>¢</i>	4.0	6.0	3.2
		: pad	8 <i>¢</i> ×6.5L	2.1	4.0	1.6	16 <i>¢</i>	6.0	7.0	3.2
							18 <i>¢</i>	6.0	8.0	3.2
1							-			
13	Standards	Satisfies Characteristic JIS C 5101-1, -1	8							

Precautions and Guidelines for Aluminum Electrolytic Capacitors

1. Guidelines for Circuit Design (General / Application guidelines for using electrolytic capacitors)

Selecting of a right capacitor is a key to a good circuit design. (1) Polarity

Most of the aluminum electrolytic capacitors are polarized. Therefore, they must be installed with the correct polarity. Usage in the reverse polarity results into a short-circuit condition that may damage or even explode the capacitor. In addition, it may influence circuit functionality. A bi-polar electrolytic capacitor should be installed when polarity across a capacitor is unstable / reversible. It should be, however, noted that usage of both polar and bi-polar capacitors are limited to DC applications. They must NOT be used for AC application.

(2) Operating Voltage

Applied DC voltage must not exceed rated voltage of the capacitor. Applying higher voltage than its rated voltage across a capacitor terminals cause overheating due to higher leakage currents and capacitor dielectric/insulation deterioration that will ultimately affect a capacitor's performance. The device, however, is capable of working under short-time transient voltages such as DC transients and peak AC ripples. Reverse voltages higher than 1 Volt within a specified temperature limit or AC voltages are not permissible. Overall, using capacitors at recommended operating voltages can prolong its lifespan. Note that the result of DC voltage overlapped with peak ripple voltage should not exceed rated voltage.

(3) Ripple Current

One of the key functions of any capacitor is removal of the ripple current i.e. the RMS value of AC flowing through a capacitor. But, a ripple current higher than rated ripple current will drop resultant capacitance, cause undue internal heating and thus reduces life span of the capacitor. In extreme cases, internal high temperature will cause the pressure relief vent to operate while destroying the device. Overall, it is important to note that an electrolytic capacitor must be used within a permissible range of ripple current. Indicators like temperature coefficient of allowable ripple current are generally used to determine life expectancy of the capacitor, but to avoid related complex calculations and for the sake of simplicity, we haven't provided temperature coefficient in the catalogue. But it offers key indicators like maximum operating temperature for calculation of life expectancy at a given temperature.

(4) Operating Temperature

Capacitors should be used within a permissible range of operating temperatures. Using capacitor at a higher temperature than maximum rated temperature will considerably shorten its life. In the worst-case scenario, high temperature can cause pressure relief vent to operate and the device will get destroyed. Using capacitors at an ambient room temperature assure their longer life.

(5) Leakage Current

Leakage current flows through a capacitor when DC voltage is applied across it. Leakage current varies with changes in ambient temperature and applied DC voltage level and its time of application. Overvoltage situation, presence of moisture, and thermal stresses, especially occurring during the soldering process can enhance leakage current. Initial leakage current is usually higher and does not decrease until voltage is applied for a certain period of time. It is recommended to keep initial leakage current within specified levels.

(6) Charge and Discharge

Regular electrolytic capacitors are not suitable for rapid charging/discharging circuits. Such usage may either cause reduction in overall capacitance or damage due to overheating. Lelon provides special assistance for selecting appropriate capacitors for rapid charging/discharging circuits.

(7) Surge Voltage

The Surge voltage rating is referred as the maximum DC overvoltage that may be applied to an electrolytic capacitor for a short time interval of 30 seconds at infrequent time intervals not exceeding 5.5minutes with a limiting resistance of 1k Ω . Unless otherwise described on the catalogue or product specifications, please do not apply a voltage exceeding the capacitor's voltage rating. The rated surge voltages corresponding to rated voltages of electrolytic capacitors are presented as follows:

Rated Voltage(V)	4	6.3	10	16	25	35	50
Surge Voltage(V)	4.6	7.3	11.5	18.4	28.8	40.3	57.5
Rated Voltage(V)	63	80	100	160	200	250	315
Surge Voltage(V)	72.5	92	115	184	230	288	347
	-	-		-	-	-	-
Rated Voltage(V)	350	400	420	450	500	525	
Surge Voltage(V)	385	440	462	495	550	578	

(8) Condition of Use

- The capacitors shall NOT be exposed to:
- (a) Fluids including water, saltwater spray, oil, fumes, highly humid or condensed climates, etc.
- (b) Ambient conditions containing hazardous gases/fumes like hydrogen sulfide, sulfurous acid, nitrous acid, chlorine or bromine gas, ammonia, etc.
- (c) Exposed to ozone, ultraviolet rays and radiation.
- (d) Severe vibrations or physical shocks that exceeds the specifications mentioned in this catalogue.

(9) Circuit Design Consideration

- (a) Please ensure whether application, operating and mounting conditions satisfy the conditions specified in the catalog before installation of a capacitor. Please consult Lelon, if any of the conditions are beyond the conditions specified in the catalog.
- (b) Heat-generating components or heat sinks should not be placed closer to Aluminum electrolytic capacitors on the PCB to avoid their premature failure. A cooling system is recommended to improve their reliable working.
- (c) Electrical characteristics and performance of aluminum electrolytic capacitors are affected by variation of applied voltage, ripple current, ripple frequency and operating temperature. Therefore, these parameters shall not exceed specified values in the catalog.
- (d) Aluminum capacitors may be connected in the parallel fashion for increasing total capacitance and/or for achieving higher ripple current capability. But, such design may cause unequal current flow through each of the capacitors due to differences in their impedances.
- (e) When two or more capacitors are connected in series, voltage across each capacitor may differ and fall below the applied voltage. A resistor should be placed across each capacitor so as to match applied voltage with voltage across a capacitor.
- (f) Please consult Lelon while selecting a capacitor for highfrequency switching circuit or a circuit that undergoes rapid charging/ discharging
- (g) Standard outer sleeve of the capacitor is not a perfect electrical insulator therefore is unsuitable for the applications that requires perfect electrical insulation. Please consult Lelon, if your application requires perfect electrical insulation.
- (h) Tilting or twisting capacitor body is not recommended once it is soldered to the PCB.

2. Caution for Assembling Capacitors

(1) Mounting

(a) Aluminum electrolytic capacitors are not recommended to reuse in other circuits once they are mounted and powered in a circuit.

- (b) Aluminum electrolytic capacitors may hold static charge between its anode and cathode, which is recommended to be discharged through a 1kΩ resistor before re-use.
- (c) A long storage of capacitors may result into its insulation deterioration. This can lead to a high leakage current when voltage is applied that may damage the capacitor. Capacitors following a long storage period must undergo voltage treatment/re-forming. Capacitors are charged by applying rated DC voltage through a resistor of $1k\Omega$ in series at least for an hour. It is recommended to increase applied voltage gradually using a voltage regulator unit once capacitors are assembled on the board. The charging
- should be followed by discharging through a $1K\Omega$ resistor. (d) Please check capacitor rated voltage before mounting.
- (e) Please check capacitor polarity before mounting.
- (f) Please don't drop capacitor on the floor / hard object.
- (g) Please don't deform the capacitor during installation.
- (h) Please confirm whether the lead spacing of the capacitors match with its pad spacing / footprint on PCB prior to installation.
- Please avoid excessive mechanical shocks to capacitor during (i) the auto-insertion process, inspection or centering operations.
- Please don't place any wiring or circuit over the capacitor's (j) pressure relief vent. The pressure relief vent may fail to open if adequate clearance space is not provided. Following table shows minimum clearance space required for different case diameters.

Case Diameter	ϕ 6.3 ~ ϕ 16	ϕ 18 ~ ϕ 35	ϕ 40 or above
Clearance (min)	2 mm	3 mm	5 mm

(2) Soldering

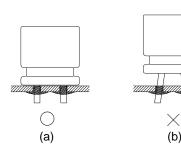
- (a) Please confirm that soldering conditions, especially temperature and contact time are within our specifications. Dip or flow soldering temperature should be limited at $260 \pm 5^{\circ}$ C for 10 ± 1 sec while manual soldering using soldering iron should be limited at $350 \pm 5^{\circ}$ C for 3 + 1/-0 seconds. Please do not dip capacitor body into molten solder. A capacitor's life will be negatively affected if these conditions are violated.
- (b) Storage of capacitors in high humidity conditions is likely to affect the solder-ability of lead wires and terminals.

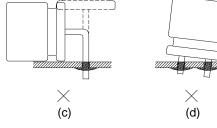
- VZH-APR-12
- (c) Reflow soldering should NOLY be used for SMD type capacitors. The temperature and duration shall not exceed the specified temperature and duration in the specification. If the temperature or duration is higher than the value specified, please consult Lelon before usage.
- (d) Standard aluminum electrolytic capacitors are not designed to withstand multiple reflow processes. Please consult Lelon if repeated reflowing is unavoidable.
- (e) Incorrect mounting on PCB with improper external strength applied on its lead wires or capacitor body after soldering may damage a capacitor's internal structure, cause short circuit, or lead to high leakage current issues. Do not bend or twist the capacitor body after soldering. Referring to the drawings below only case (i) is recommended. (i)
 - Correct soldering
 - Hole-to-hole spacing on PCB differs from the lead space of (ii) lead wires.
 - (iii) Lead wires are bent after soldering.
 - (iv) Capacitor body doesn't stand vertical on PCB after soldering.

(3) Cleaning Circuit Boards after Soldering

- (a) Following chemicals are not recommended for cleaning: Solvent containing halogen ions, Alkaline solvent, Xylene, Acetone, Terpene, petro-based solvent.
- (b) Recommended cleaning conditions:

Fatty-alcohol - Pine Alpha ST-100S, Clean Through-750H and IPA (isopropyl alcohol) are examples of the most acceptable cleaning agents. Temperature of the cleaning agent must not exceed 60°C. Flux content in the cleaning agents should be limited to 2 Wt. %. Overall length of cleaning process (e.g., immersion, ultrasonic or other) shall be within 5 minutes (5 \sim 7mm height within 3 minutes). CFC substitute cleaning agents such as AK225AES can also be used for cleaning. In this case, its temperature shall not exceed 40 C and cleaning process (e.g., immersion, ultrasonic or other) shall be completed within 2 ~ 3 minutes. After cleaning capacitors should be dried with hot air for at least 10 minutes along with the PCB. Temperature of hot air shall not exceed maximum category temperature of the capacitor. Insufficient drying may cause appearance defects, sleeve shrinkage, and bottom-plate bulging. However, usage of this CFC substitute must completely regulated for protection of environment.





3. Maintenance Inspection

Periodical inspection of aluminum capacitors is absolutely necessary, especially when they are used with industrial equipment. The following items should be checked:

- (1) Appearance: Bloated, vent operated, leaked, etc.
- (2) Electrical characteristic: Capacitance, Tanδ, leakage current, and other specified items listed in specification.

Lelon recommend replacing the capacitors if any of the abovementioned items fail to meet specifications.

4. Storage

ſς

- (1) The most suitable conditions for aluminum capacitor storage are 5 °C ~ 35°C and indoor relative humidity less than 75%. High temperature and/or humidity storage is detrimental to the capacitors.
- (2) Capacitors shall not be stored in wet or damp atmospheres containing water, brine, fumes or oil.
- Capacitors storage area shall neither be exposed to hazardous gases such as hydrogen sulfide, sulfurous acid, nitrous acid, chlorine, ammonium, etc. nor to acidic or alkaline solutions.
- (4) Capacitors shall not be exposed to ozone, ultraviolet rays or radiation.

5. Estimation of life time

$$L_r = L_0 \times 2^{\frac{T_{0\text{max}} - T_{r\text{max}}}{10}}$$

- Lr: Estimated lifetime (hours)
- L₀: Base lifetime specified at maximum operating temperature with applied the DC voltage and the ripple current (hours)
- $T_{0 \text{ max}}$: The core temperature that rated ripple current applied at maximum operating temperature.
- $T_{r\,\text{max}}$. The core temperature that applied actual ripple current at ambient temperature.

6. Disposal

Please consult with a local industrial waste disposal specialist when disposing of aluminum electrolytic capacitors

7. Environmental Consideration

Lelon already have received ISO 14000 certificate. Cadmium (Cd), Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr⁺⁶), PBB, PBDE, DEHP, BBP, DBP and DIBP have never been using in capacitor. If you need "Halogen-free" products, please consult with us.

8. AEC-Q200 Compliance

Automotive Electronics Counsel (AEC) has established various electronic component qualification/reliability standards in order to serve automotive electronics industry. AEC-Q200 standard is dedicated for passive components like capacitors, inductors, etc. and is widely adopted domestically as well as internationally. Lelon offers compliant product designs and support services to satisfy customers' product requirements, including the AEC-Q200 required criteria of the reliability tests. Lelon's capacitors are professionally designed to outperform all requirements of AEC-Q200.

For further details, please refer to

IEC 60384-4- Fixed capacitors for use in electronic equipment – Part 4: Sectional specification – Aluminium electrolytic capacitors with solid (MnO₂) and non-solid electrolyte (Established in January 1995, Revised in March 2007), and

EIAJ RCR-2367B- Guideline of notabilia for fixed aluminium electrolytic capacitors for use in electronic equipment [Technical Standardization Committee on Passive Components (Established in March 1995, Revised in March 2002)].